### **RENESAS** High Performance Relative Humidity and Temperature Sensor

### Description

The HS300x (HS3001, HS3002, HS3003, and HS3004) series is a highly accurate, fully calibrated relative humidity and temperature sensor. The MEMS sensor features a proprietary sensor-level protection, ensuring high reliability and long-term stability.

Integrated calibration and temperature-compensation logic provides fully corrected RH and temperature values via a standard I2C output. No user calibration of the output data is required.

The high accuracy, fast measurement response time, and longterm stability combined with the small package size makes the HS300x series ideal for a wide number of applications ranging from portable devices to products designed for harsh environments.

The HS300x series digital sensor accurately measures relative humidity and temperature levels. The measured data is internally corrected and compensated for accurate operation over a wide range of temperature and humidity levels – user calibration is not required.

# **Typical Applications**

- Climate control systems
- Home appliances
- Weather stations
- Industrial automation
- Medical equipment
- Automotive cabin climate control

#### Features

- Humidity range: 0% to 100% RH
- Humidity accuracy: ±1.5% RH, typical (HS3001, 10 to 90% RH, 25°C)
- 14-bit resolution: 0.01%RH, typical
- Independent programmable resolution settings: 8, 10, 12, 14 bits
- Fast RH response time: 1 second time constant, typical (with 1 m/sec air flow), 4 seconds time constant, typical (in still air)
- Temperature sensor accuracy: ±0.2°C, typical (HS3001, HS3002, -10 to +80°C)
- Low current consumption: 1.0µA average (8-bit resolution, 1.8V supply), 24.4µA average (14-bit resolution, 3.3V supply), one RH and temperature measurement per second
- Excellent stability against aging
- Highly robust protection from harsh environmental conditions and mechanical shock
- Very low power consumption

### **Physical Characteristics**

- Supply voltage: 2.3V to 5.5V
- Extended supply voltage: 1.8V (-20°C to +125°C)
- Operating temperature: -40°C to +125°C
- 3.0 × 2.41 × 0.8 mm DFN-style 6-LGA package

### **Product Image**



## Contents

1.	Pin Assignments4					
2.	Pin Descriptions					
3.	Absolute Maximum Ratings					
4.	Reco	ommended Operating Conditions	5			
5.	Hum	Humidity and Temperature Sensor Performance				
	5.1	Humidity Sensor Specification	6			
	5.2	Temperature Sensor Specification	7			
	5.3	Sleep Current	7			
	5.4	Humidity Sensor Accuracy Graphs	8			
	5.5	Temperature Sensor Accuracy Graphs	9			
6.	Sens	sor Interface	10			
	6.1	I2C Features and Timing	10			
	6.2	Sensor Slave Address	10			
	6.3	I2C Communication	11			
	6.4	Measurement Mode	11			
	6.5	Measurement Requests (MR)	11			
	6.6	Data Fetch (DF)	12			
	6.7	Status Bits	13			
	6.8	Accessing the Non-volatile Memory	13			
	6.9	Setting the Measurement Resolution	14			
	6.10	Reading the HS300x ID Number	14			
7.	Calc	ulating Humidity and Temperature Output	15			
8.	Appl	ication Circuit	15			
9.	Package Outline Drawings					
10.	Soldering Information					
11.	PCB Layout Guide					
12.	Storage and Handling					
13.	Quality and Reliability1					
14.	Orde	ering Information	18			
15.	Revision History					

# **List of Figures**

Figure 1.	Pin Assignments for 3mm × 2.41mm 6-LGA Package (Top View)	4
Figure 2.	Sleep Current Variation over Temperature, V <sub>DD</sub> at 3.3V	7
Figure 3.	HS3001 RH Accuracy Tolerance at 25°C	8
Figure 4.	HS3001 RH Accuracy over Temperature	8
Figure 5.	HS3002 RH Accuracy Tolerance at 25°C	8

#### RENESAS

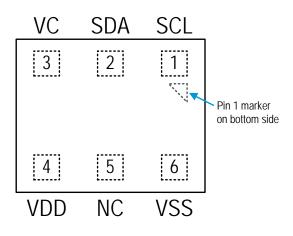
Figure 6.	HS3002 RH Accuracy over Temperature	8
Figure 7.	HS3003 RH Accuracy Tolerance at 25°C HS3003 RH Accuracy over Temperature	8
Figure 8.	HS3003 RH Accuracy over Temperature	8
Figure 9.	HS3004 RH Accuracy Tolerance at 25°C	9
Figure 10.	HS3004 RH Accuracy over Temperature	9
	HS3001/HS3002 Temperature Sensor Accuracy Tolerance	
Figure 12.	HS3003 Temperature Sensor Accuracy Tolerance	9
Figure 13.	HS3004 Temperature Sensor Accuracy Tolerance	9
Figure 14.	Timing Diagram	10
Figure 15.	START and STOP Condition Waveform	11
Figure 16.	Measurement Request	11
Figure 17.	Data Fetch	12
	Sequence of Commands to Enter Programming Mode	
	Sequence of Commands to Change the Relative Humidity Resolution	
Figure 20.	HS300x Application Circuit (Top View)	15
Figure 21.	Recommended Soldering Profile	.16
Figure 22.	Milled PCB Openings for Thermal Isolation	.17

## **List of Tables**

Table 1.	Pin Descriptions	4
Table 2.	Absolute Maximum Ratings	5
Table 3.	Operating Conditions	5
Table 4.	Humidity Sensor Specification, T <sub>A</sub> = +25°C, V <sub>DD</sub> = 2.3V to 5.5V	6
	Temperature Sensor Specification, $T_A = +25$ °C, $V_{DD} = 2.3V$ to 5.5V	
Table 6.	I2C Timing Parameters	.10
Table 7.	Status Bits	.13
Table 8.	Non-volatile Memory Registers	.13
	Register Values for Different Resolution Settings	

### 1. Pin Assignments

#### Figure 1. Pin Assignments for $3mm \times 2.41mm$ 6-LGA Package (Top View)



### 2. Pin Descriptions

#### Table 1. Pin Descriptions

Pin Number	Name	Туре	Description
1	SCL	In/out	Serial clock
2	SDA	SDA In/out Serial data	
3	VC	—	Connect a 0.1µF decoupling capacitor from VC to ground
4	VDD	In	Supply voltage
5	NC	_	Do not connect
6	VSS	In	Ground

[a] "NC" stands for not connected / no connection required / not bonded.

V

V

°C

μA

μA

ms

#### **Absolute Maximum Ratings** 3.

The absolute maximum ratings are stress ratings only. Stresses greater than those listed below can cause permanent damage to the device. Functional operation of the HS300x at absolute maximum ratings is not implied. Exposure to absolute maximum rating conditions might affect device reliability.

Table 2. **Absolute Maximum Ratings** 

Symbol	Parameter	Conditions	Minimum	Maximum	Unit
	Analog Supply Voltage		-0.3	6.0	V
	Storage Temperature Range		-55	125	°C

#### 4. **Recommended Operating Conditions**

Important note: The HS300x series sensors are optimized to perform best in the more common temperature and humidity ranges of 10°C to 50°C and 20% RH to 80% RH, respectively. If operated outside of these conditions for extended periods, especially at high humidity levels, the sensors may exhibit an offset. In most cases, this offset is temporary and will gradually disappear once the sensor is returned to normal temperature and humidity conditions. The amount of the shift and the duration of the offset vary depending on the duration of exposure and the severity of the relative humidity and temperature conditions. The time needed for the offset to disappear can also be decreased by using the procedures described in sections 10 and 12.

#### **Operating Conditions** Condition Minimum Maximum Unit Parameter Typical **Operating Supply Voltage** 3.3 5.5 Extended Operating Supply Voltage Operating temperature from -20 to 125°C 1.8 5.5 **Operating Humidity Range** 0 100 %RH -40 125 **Operating Temperature Sensor Range** -40 to 85°C 0.6 Sleep Current 1 Sleep Mode -40 to 125°C 1 3 8-bit resolution 1.0 1.5 1.7 2.6 10-bit resolution 2.0 2.8 One RH + temperature Average Current<sup>[a]</sup> measurement/second 5.5 7.0 12-bit resolution 7.1 14-bit resolution 20.1 24.4 24.4 0.10 Wake-up 8-bit resolution 0.55 Humidity or temperature Measurement Time 10-bit resolution 1.31 including the digital 12-bit resolution 4.50 compensation 14-bit resolution 16.90

#### Table 3.

[a] Minimum, typical and maximum average currents are given at 1.8V, 3.3V and 5.5V V<sub>DD</sub> respectively.

# 5. Humidity and Temperature Sensor Performance

### 5.1 Humidity Sensor Specification

#### Table 4. Humidity Sensor Specification, $T_A = +25$ °C, $V_{DD} = 2.3V$ to 5.5V

Parameter		Condition		Typical	Maximum	Unit	
Operating Range			0		100	%RH	
	HS3001	10% to 00% DU		±1.5	±1.8		
Accurcov	HS3002	10% to 90%RH		±1.8	±2.0		
Accuracy <sup>[a]</sup>	HS3003	- 20% to 80%RH		±2.5	±3.5	%RH	
	HS3004	20% IU 80%RH		±3.5	±4.5		
Decolution	8-bit			0.7	1.0	%RH	
Resolution	14- bit			0.01	0.015	%RH	
Hysteresis					±1.0	%RH	
Noise in Humidity (RMS)	14-bit			0.014		%RH	
	HS3001	- 10% to 90%RH					
Non Linearity from Decisiona Curus	HS3002			±0.15	0.05	%RH	
Non-Linearity from Response Curve	HS3003				±0.25	%RH	
	HS3004	- 20% to 80%RH					
Long-Term Stability				±0.1	±0.25	%RH/Yr	
Response Time Constant <sup>[b]</sup> (TH)	20% to 80% flow	20% to 80% RH, 1 meter/sec air flow		1		sec	
	20% to 80%	20% to 80% RH Still Air		4.0	6.0		

[a] Monotonic increases from 10 to 90% RH after sensor has been stabilized at 50% RH.

[b] Initial value to 63% of total variation.

### 5.2 Temperature Sensor Specification

#### Table 5. Temperature Sensor Specification, $T_A = +25^{\circ}C$ , $V_{DD} = 2.3V$ to 5.5V

Parameter	(	Condition		Typical	Maximum	Unit
Range			-40		125	°C
	HS3001	-10°C to 80°C		±0.2		
Acouroov	HS3002			±0.2	±0.3	°C
Accuracy	HS3003	0°C to 70°C		±0.25	±0.35	°C
	HS3004			±0.3	±0.5	
Resolution	8- bit	8- bit		0.9	1.5	°C
Resolution	14-bit	14-bit		0.015	0.025	C
Response Time Constant <sup>[a]</sup> ( $\tau_T$ )			20			Sec.
Long-Term Stability					0.02	°C/Yr
Supply Voltage Dependency [h]	VDD ≥ 2.8\	VDD ≥ 2.8V		0.03	0.1	°C/V
Supply Voltage Dependency <sup>[b]</sup>	1.8V < VDE	1.8V < VDD < 2.8V		1.25	2.25	°C/V

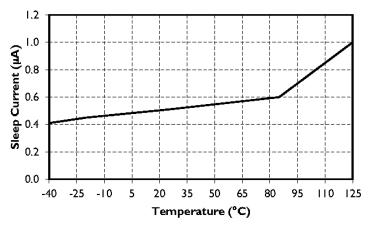
[a] Response time depends on system thermal mass and air flow.

[b] Temperature accuracy can be optimized for specified supply voltages upon request.

#### 5.3 Sleep Current

The sleep current of the HS300x series depends on the operating temperature, as shown in the following figure. Note that there is no significant dependence of the sleep current on the supply voltage.

Figure 2. Sleep Current Variation over Temperature, VDD at 3.3V



#### **Humidity Sensor Accuracy Graphs** 5.4

The typical and maximum relative humidity sensor accuracy tolerances are shown in the following figures.

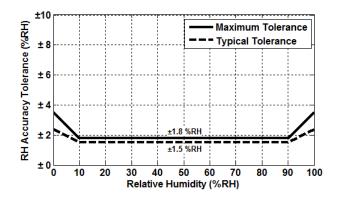


Figure 3. HS3001 RH Accuracy Tolerance at 25°C



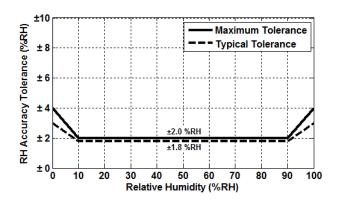
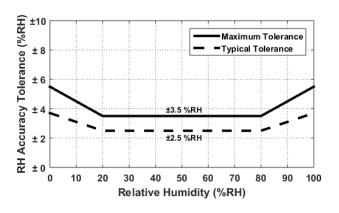


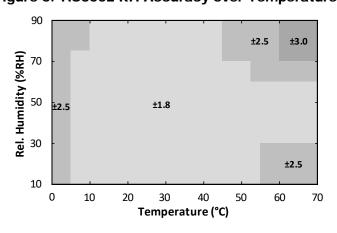
Figure 7. HS3003 RH Accuracy Tolerance at 25°C

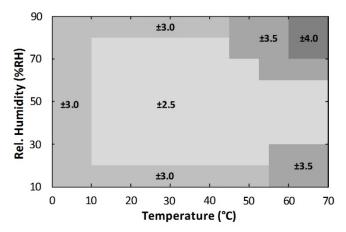


90 ±2.0 ±2.5 ±3.0 70 ±2.0 50 ±1.5 +2.0

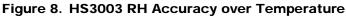
Figure 4. HS3001 RH Accuracy over Temperature



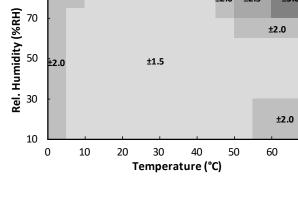




8

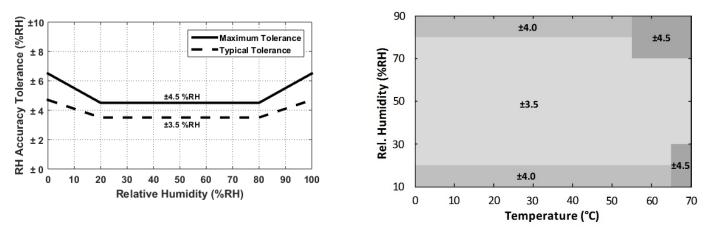


70



#### Figure 9. HS3004 RH Accuracy Tolerance at 25°C





#### 5.5 Temperature Sensor Accuracy Graphs

The typical and maximum temperature sensor accuracy tolerances are shown in the following figures.

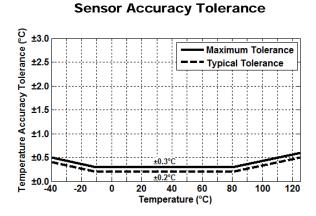
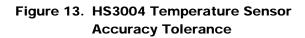


Figure 11. HS3001/HS3002 Temperature



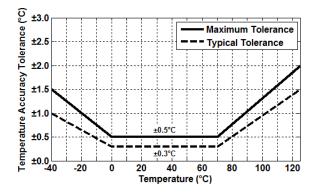
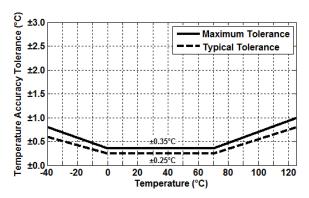


Figure 12. HS3003 Temperature Sensor Accuracy Tolerance



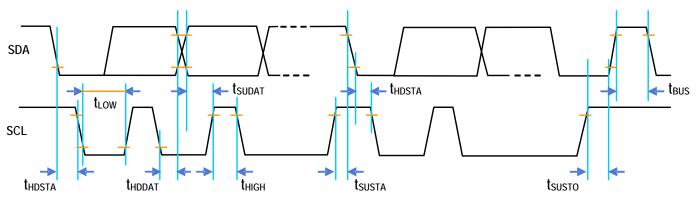
### 6. Sensor Interface

The HS300x series sensor uses a digital I2C-compatible communication protocol. To accommodate multiple devices, the protocol uses two bi-directional open-drain lines: the Serial Data Line (SDA) and the Serial Clock Line (SCL). Pull-up resistors to  $V_{DD}$  are required. Several slave devices can share the bus; however only one master device can be present on the line.

### 6.1 I2C Features and Timing

The HS300x series sensor operates as a slave device on the I2C bus with support for 100kHz and 400kHz bit rates. Each transmission is initiated when the master sends a 0 START bit (S), and the transmission is terminated when the master sends a 1 STOP bit (P). These bits are only transmitted while the SCL line is HIGH.

#### Figure 14. Timing Diagram



#### Table 6. I2C Timing Parameters

Parameter	Symbol	Minimum	Typical	Maximum	Unit
SCL Clock Frequency <sup>[a]</sup>	f <sub>SCL</sub>	20		400	kHz
START Condition Hold Time Relative to SCL Edge	thdsta	0.1			μs
Minimum SCL Clock LOW Width <sup>[b]</sup>	t∟ow	0.6			μs
Minimum SCL Clock HIGH Width <sup>[b]</sup>	tнigн	0.6			μs
START Condition Setup Time Relative to SCL Edge	<b>t</b> susta	0.1			μs
Data Hold Time on SDA Relative to SCL Edge	thddat	0		0.5	μs
Data Setup Time on SDA Relative to SCL Edge	tsudat	0.1			μs
STOP Condition Setup Time on SCL	tsusтo	0.1			μs
Bus Free Time Between STOP Condition and START Condition	tøus	1			μs

[a] The minimum frequency of 20kHz applies to test only; no minimum under normal operations.

[b] Combined LOW and HIGH widths must equal or exceed the minimum SCL period.

### 6.2 Sensor Slave Address

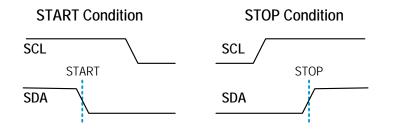
The HS300x series default I2C address is 44<sub>HEX.</sub> The device will respond only to this 7-bit address. See section 6.3 for further information. Custom I2C address can be provided upon request.

#### 6.3 I2C Communication

The sensor transmission is initiated when the master sends a 0 START bit (S). The transmission is terminated when the master sends a 1 STOP bit (P). These bits are only transmitted while the SCL line is HIGH (see Figure 155 for waveforms).

Once the START condition has been set, the SCL line is toggled at the prescribed data rate, clocking subsequent data transfers. Data on the SDA line is always sampled on the rising edge of the SCL line and must remain stable while SCL is HIGH to prevent false START or STOP conditions.

#### Figure 15. START and STOP Condition Waveform



After the START bit, the master device sends the 7-bit slave address (see section 6.2) to the HS300x, followed by the read/write bit, which indicates the transfer direction of any subsequent data. This bit is set to 1 to indicate a read from slave to master or set to 0 to indicate a write from master to slave.

All transfers consist of 8 bits and a response bit: 0 for Acknowledge (ACK) or 1 for Not Acknowledge (NACK). After the ACK is received, another data byte can be transferred or the communication can be stopped with a STOP bit.

### 6.4 Measurement Mode

The HS300x is factory-programmed to operate in Sleep Mode. In Sleep Mode, the sensor waits for commands from the master before taking measurements. The digital core only performs conversions when it receives a *Measurement Request* command (MR); otherwise, it is always powered down.

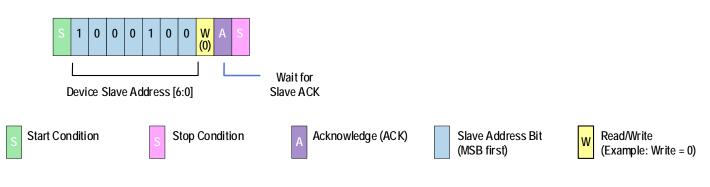
### 6.5 Measurement Requests (MR)

The MR command is required to wake up the HS300x from its Sleep Mode. Initiate the Measurement Request by sending the 7-bit slave address followed by an eighth bit = 0 (WRITE).

A measurement cycle consists of a humidity and temperature conversion followed by the digital signal processor (DSP) correction calculations. At the end of a measurement cycle, the digital output register will be updated before powering down.

The output is always scaled to 14 bits. The order of the bits is big-endian.

#### Figure 16. Measurement Request



### 6.6 Data Fetch (DF)

At the end of a measurement cycle, valid data can be fetched. The status bits of the DF results can be used to detect if the data is valid or stale (see section 6.7); otherwise, wait for the measurements to complete before performing the DF.

The DF command starts with the 7-bit slave address followed by an eighth bit = 1 (READ). The HS300x as a slave sends an acknowledge (ACK) indicating success.

The number of data bytes returned by the HS300x is determined by when the master sends the NACK and STOP condition. The full 14 bits of the humidity data are fetched in the first two bytes. The two MSBs of the first byte are the status bits.

The 14 bits of temperature data follow the humidity data. The last two bits (LSBs) of the fourth data byte are undetermined and should be masked off. In the event that the temperature data is not needed, the read can be terminated by sending a NACK after the second byte.

Alternatively, if only 8-bit resolution is desired for the temperature output, the read can be terminated after the 3<sup>rd</sup> byte by issuing a NACK followed by a stop bit. The measurement time depends on the configured sensor resolution. The following table lists examples when the resolutions for the relative humidity and temperature measurements are the same. For different relative humidity and temperature resolution settings, the measurement times in 3 should be used, along with the 0.1 ms wake-up time.

For example, an 8-bit relative humidity measurement and a 12-bit temperature measurement results in a total measurement time of:

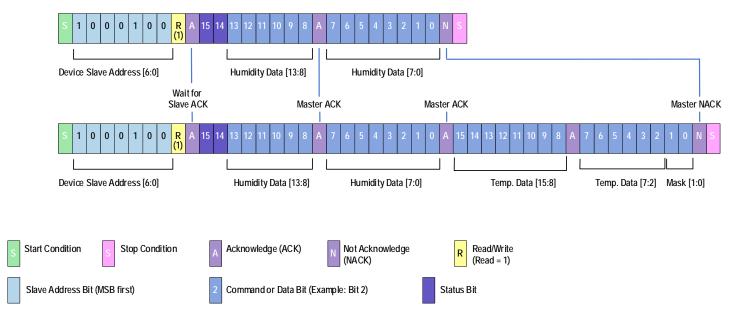
0.1 ms + 0.55 ms + 4.5 ms = 5.15 ms.

RH+T measurement times (including wake-up time) at different resolution settings.

Resolution <sup>1</sup> (bits)	Measurement time (ms)
8	1.20
10	2.72
12	9.10
14	33.90

<sup>1</sup>Same resolutions are assumed for both relative humidity and temperature.

#### Figure 17. Data Fetch



### 6.7 Status Bits

The status bits are used to indicate the current state of the fetched data. The two MSBs of the humidity data byte are the status bits (see the following table).

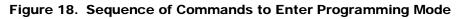
	Definition							
	00 <sub>B</sub>	Valid Data: Data that has not been fetched since the last measurement cycle						
01 <sub>B</sub> Stale Data: Data that has already been fetched since the last measurement cycle								
		Note: If a data fetch is performed before or during the first measurement after power-on reset, then the stale status will be						

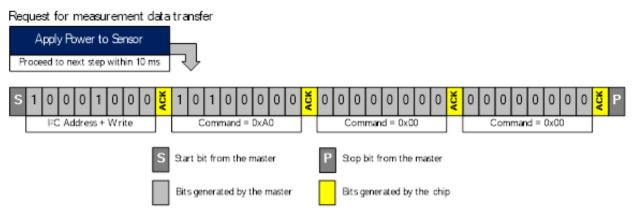
#### Table 7.Status Bits

#### 6.8 Accessing the Non-volatile Memory

The HS300x series non-volatile memory stores its measurement resolution setting and its ID number. To change the sensor resolution or read the ID number, the master must place the HS300x into programming mode while the chip is powering up. The figure below shows the sequence of commands needed to enter the programming mode, which must be sent within **10ms** after applying power to the sensor. The master must send the I<sup>2</sup>C address and a Write bit followed by the command **0xA0|0x00**|**0x00**.

returned, but this data is actually invalid since the first measurement has not been completed.





This command takes 120µs to process, after which the master has access to the non-volatile memory registers listed in the following table. All of these registers are 16 bits wide.

To return to normal sensor operation and perform measurements, the master must send the I<sup>2</sup>C address and a Write bit, followed by the command: 0x80|0x00|0x00.

Address	Register Description	
0x06	Humidity Sensor Resolution – Read Register (bits [11:10])	
0x46	Humidity Sensor Resolution – Write Register (bits [11:10])	
0x11	Temperature Sensor Resolution – Read Register (bits [11:10])	
0x51	Temperature Sensor Resolution – Write Register (bits [11:10])	
0x1E	Read Sensor ID – Upper 2 bytes	
0x1F	Read Sensor ID – Lower 2 bytes	

### 6.9 Setting the Measurement Resolution

The HS300x series relative humidity and temperature measurement resolutions can be set *independently* to 8, 10, 12, or 14-bits by writing to the non-volatile memory, and are initially set to 14-bits by default. The procedure to set the humidity sensor resolution is illustrated in the following figure. The relative humidity and temperature resolution can be read in registers 0x06 and 0x11, respectively, or written in registers 0x46 or 0x51. The resolution information is stored in bits [11:10] of these registers, as listed in the Table 10. All of the other bits in these registers must be left unchanged. As such, before writing new resolution settings, the contents of the read registers must be read, and only bits [11:10] can be changed in the write registers. Once bits [11:10] are changed to set the desired resolution, the entire register must be written back to the HS300x sensor.



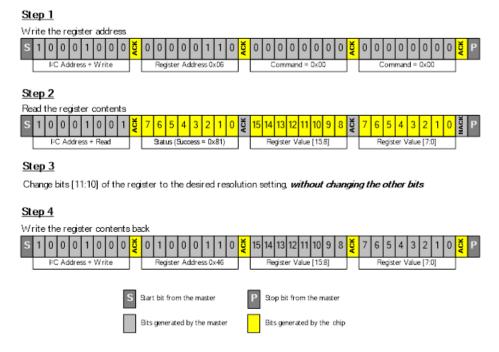


 Table 9.
 Register Values for Different Resolution Settings

Resolution register bits [11:10]	Resolution (bits)
00 <sub>B</sub>	8
01 <sub>B</sub>	10
10 <sub>B</sub>	12
11 <sub>B</sub>	14

The sensor non-volatile memory requires 120µs to load the data into the registers after step 1, and requires 14ms to write the data after step 4. *Failure to comply with these processing times may result in data corruption and introduce errors in sensor measurements.* The procedure to change the temperature sensor resolution is the same as that depicted in Figure 19, except the register address in Step 1 must be set to **0x11** and the register address in Step 4 will be **0x51**.

### 6.10 Reading the HS300x ID Number

The sensor ID is a 32-bit number, and can be read in a similar fashion as illustrated in steps 1 and 2 of Figure 19, using the appropriate register address values. The ID number is stored in two registers, with the upper and lower 16 bits stored in register addresses **0x1E and 0x1F**, respectively.

$$Humidity [\% RH] = \left(\frac{Humidity [13:0]}{2^{14} - 1}\right) * 100$$
 Equation 1

The entire output of the HS300x is 4 bytes. The relative humidity (in percent) and the temperature (in degrees Celsius) are calculated with

$$Temperature [{}^{\circ}C] = \left(\frac{Temperature [15:2]}{2^{14} - 1}\right) * 165 - 40$$

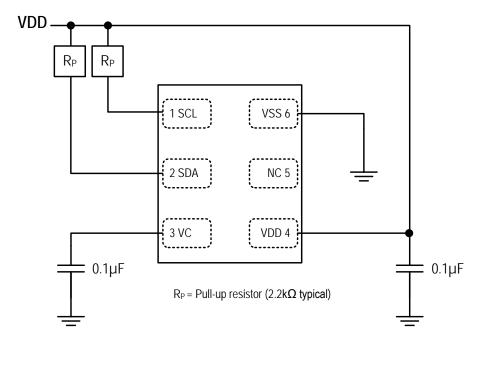
**Calculating Humidity and Temperature Output** 

8. Application Circuit

#### Figure 20. HS300x Application Circuit (Top View)







7.

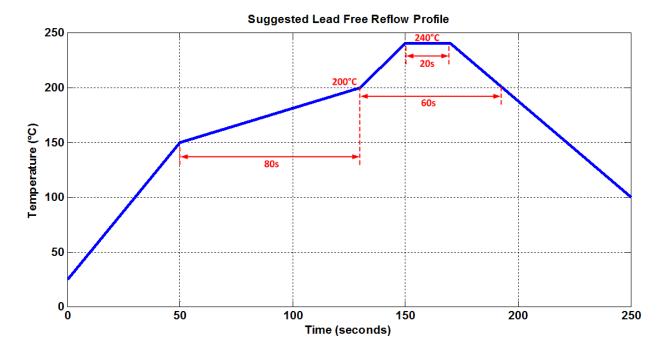
### 9. Package Outline Drawings

The package outline drawings are located at the end of this document and are accessible from the Renesas website. The package information is the most current data available and is subject to change without revision of this document.

## **10.** Soldering Information

This section discusses soldering considerations for the HS300x. When a relative humidity sensor is exposed to the high heat associated with the soldering process, the sensor element tends to dry out. To avoid an offset in the relative humidity readings, the sensor element must be rehydrated after the soldering process. Care must also be taken when selecting the temperatures and durations involved in the soldering process to avoid irreversibly damaging the sensor element.

The recommended soldering profile for a lead-free (RoHS-compliant) process is shown below.



#### Figure 21. Recommended Soldering Profile

It is important to ensure this temperature profile is measured at the sensor itself. Measuring the profile at a larger component with a higher thermal mass means the temperature at the small sensor will be higher than expected.

For manual soldering, the contact time must be limited to 5 seconds with a maximum iron temperature of 350°C.

In either case, a board wash after soldering is **not** recommended. Therefore, if a solder paste is used, it is strongly recommended that a "**no-clean**" solder paste is used to avoid the need to wash the PCB.

After soldering, the recommended rehydration conditions are either:

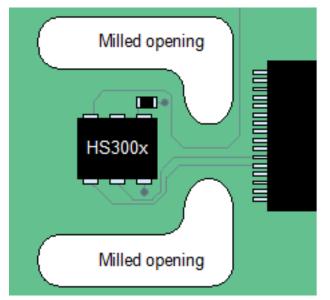
- A relative humidity of 75% RH at room temperature for at least 12 hours
- A relative humidity of 40% to 50% RH at room temperature for 3 to 5 days

Otherwise, in the relative humidity readings, there might be an initial offset, which will slowly disappear as the sensor is exposed to ambient conditions.

### 11. PCB Layout Guide

When designing the PCB, undesired heat transfer paths to the HS300x series must be minimized. Excessive heat from other components on the PCB will result in inaccurate temperature and relative humidity measurements. As such, *solid metal planes for power supplies should be avoided in the vicinity of the sensor* since these will act as thermal conductors. To further reduce the heat transfer from other components on the board, openings can be milled into the PCB as shown in Figure 21.





### 12. Storage and Handling

Recommendation: Once the sensors are removed from their original packaging, store them in metal-in antistatic bags.

Avoid using polyethylene antistatic bags as they may affect sensor accuracy.

The nominal storage conditions are 10 to 50°C and humidity levels within 20% to 60%RH. If stored outside of these conditions for extended periods of time, the sensor readings may exhibit an offset. The sensor can be reconditioned and brought back to its calibration state by applying the following procedure:

- 1. Bake at a temperature of 100°C with a humidity < 10%RH for 10 to 12 hours.
- 2. Rehydrate the sensor at a humidity of 75% RH and a temperature between 20 to 30°C for 12 to 14 hours.

### 13. Quality and Reliability

The HS300x series is available as a qualified product for consumer and industrial market applications. All data specified parameters are guaranteed if not stated otherwise.

# 14. Ordering Information

Part Number	Description and Package	Carrier Type	Temp. Range
HS3001	Digital Relative Humidity and Temperature Sensor. $\pm 1.5\%$ RH (Typical), $3.0 \times 2.41 \times 0.8$ mm, 6-LGA (LHG6D1)	Таре	-40°C to +125°C
HS3002	Digital Relative Humidity and Temperature Sensor. ±1.8%RH (Typical), 3.0 × 2.41 × 0.8mm, 6-LGA ( <u>LHG6D1</u> )	Таре	-40°C to +125°C
HS3003	Digital Relative Humidity and Temperature Sensor. ±2.5%RH (Typical), 3.0 × 2.41 × 0.8mm, 6-LGA ( <u>LHG6D1</u> )	Таре	-40°C to +125°C
HS3004	Digital Relative Humidity and Temperature Sensor. ±3.5%RH (Typical), 3.0 × 2.41 × 0.8mm, 6-LGA (LHG6D1)	Таре	-40°C to +125°C

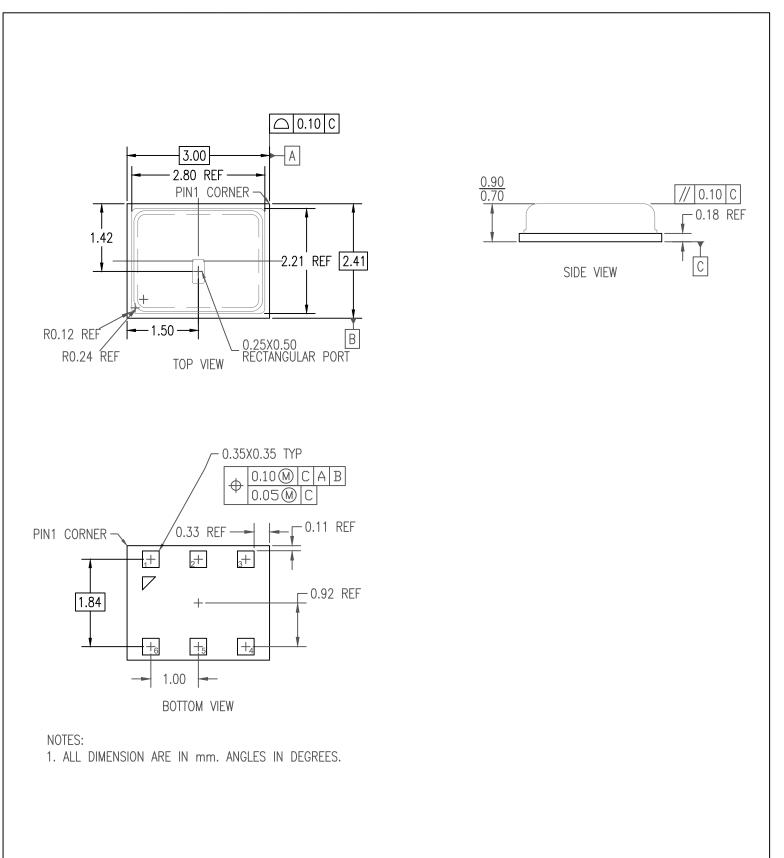
## **15. Revision History**

Revision Date	Description of Change		
August 9, 2021	Corrected the storage temperature range in Table 2.		
April 21, 2021	<ul><li>Clarified humidity and temperature operating range in Table 3.</li><li>Completed other minor changes</li></ul>		
March 10, 2021	<ul><li>Corrected Figure 8 and 10 tolerance</li><li>Completed other minor changes</li></ul>		
April 20, 2020	<ul> <li>Updated Table 3, 4, 5 specs</li> <li>Added non-volatile memory programming instruction</li> <li>Added measurement resolution programming and reading sensor ID instructions</li> <li>Added PCB layout guide</li> </ul>		
August 6, 2018	Updated temperature sensor response time in Table 5.		
April 24, 2018	<ul> <li>Clarified Figure 16 and Figure 17.</li> <li>Update for Equation 2.</li> <li>Edits for section 6.6.</li> <li>Template updates for section 9.</li> </ul>		
February 14, 2018	Changed operating voltage and added recommended operating conditions.		
November 8, 2017	Initial release.		

# RENESAS

# **6-LGA Package Outline Drawing**

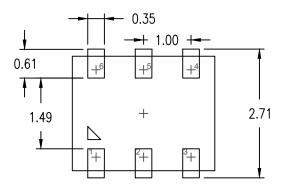
3.0 x 2.41 x 0.8 mm Body, 1.0mm Pitch LHG6D1, PSC-4719-01, Rev 01, Page 1





### **6-LGA Package Outline Drawing**

3.0 x 2.41 x 0.8 mm Body, 1.0mm Pitch LHG6D1, PSC-4719-01, Rev 01, Page 2



RECOMMENDED LAND PATTERN DIMENSION

NOTES:

- 1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
- 2. TOP DOWN VIEW. AS VIEWED ON PCB.
- 3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

Package Revision History				
Date Created	Rev No.	Description		
June 25, 2018	Rev 01	Revise Lead Length		
Sept 25, 2017	Rev 00	Initial Release		

#### IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

#### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

#### **Trademarks**

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

#### **Contact Information**

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

 Renesas Electronics:

 HS3002
 HS3003
 HS3001
 HS3004